

| <b>PCN Number:</b>  | 20180213001  |                                       | <b>PCN Date:</b>   | Feb 15 2018                         |                          |          |      |                |         |                   |
|---|--|---------------------------------------|--|-------------------------------------|--------------------------|----------|------|----------------|---------|-------------------|
| <b>Title:</b>   | Qualification of Carsem Suzhou as an additional Assembly and Test Site and for TPS65197BRUYR/T Devices |                                       |  |                                     |                          |          |      |                |         |                   |
| <b>Customer Contact:</b>  | <a href="#">PCN Manager</a>  | <b>Dept:</b>                          | Quality Services   |                                     |                          |          |      |                |         |                   |
| <b>Proposed 1<sup>st</sup> Ship Date:</b>   | May 15 2018  | <b>Estimated Sample Availability:</b> | Provided upon Request  |                                     |                          |          |      |                |         |                   |
| <b>Change Type:</b>   |  |                                       |  |                                     |                          |          |      |                |         |                   |
| <input checked="" type="checkbox"/>   | Assembly Site  | <input type="checkbox"/>              | Assembly Process   | <input checked="" type="checkbox"/> | Assembly Materials       |          |      |                |         |                   |
| <input type="checkbox"/>  | Design   | <input type="checkbox"/>              | Electrical Specification   | <input type="checkbox"/>            | Mechanical Specification |          |      |                |         |                   |
| <input checked="" type="checkbox"/>   | Test Site  | <input type="checkbox"/>              | Packing/Shipping/Labeling  | <input type="checkbox"/>            | Test Process             |          |      |                |         |                   |
| <input type="checkbox"/>  | Wafer Bump Site  | <input type="checkbox"/>              | Wafer Bump Material  | <input type="checkbox"/>            | Wafer Bump Process       |          |      |                |         |                   |
| <input type="checkbox"/>  | Wafer Fab Site   | <input type="checkbox"/>              | Wafer Fab Materials  | <input type="checkbox"/>            | Wafer Fab Process        |          |      |                |         |                   |
|   |  | <input type="checkbox"/>              | Part number change   |                                     |                          |          |      |                |         |                   |
| <b>PCN Details</b>  |  |                                       |  |                                     |                          |          |      |                |         |                   |
| <b>Description of Change:</b>   |  |                                       |  |                                     |                          |          |      |                |         |                   |
| Texas Instruments is pleased to announce the qualification of Carsem Suzhou as an additional Assembly and test site for the TPS65197BRUYR/T device. Construction differences are as follows:          |  |                                       |  |                                     |                          |          |      |                |         |                   |
| <table border="1"> <thead> <tr> <th>What</th> <th>TI Clark</th> <th>CARZ</th> </tr> </thead> <tbody> <tr> <td>Mount Compound</td> <td>4207768</td> <td><b>SID#435143</b></td> </tr> </tbody> </table> |  |                                       |  |                                     | What                     | TI Clark | CARZ | Mount Compound | 4207768 | <b>SID#435143</b> |
| What  | TI Clark   | CARZ                                  |  |                                     |                          |          |      |                |         |                   |
| Mount Compound  | 4207768  | <b>SID#435143</b>                     |  |                                     |                          |          |      |                |         |                   |
| Test coverage, insertions, conditions will remain consistent with current testing and verified with test MQ.  |  |                                       |  |                                     |                          |          |      |                |         |                   |
| <b>Reason for Change:</b>   |  |                                       |  |                                     |                          |          |      |                |         |                   |
| Continuity of Supply  |  |                                       |  |                                     |                          |          |      |                |         |                   |
| <b>Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):</b>   |  |                                       |  |                                     |                          |          |      |                |         |                   |
| None  |  |                                       |  |                                     |                          |          |      |                |         |                   |
| <b>Anticipated impact on Material Declaration</b>   |  |                                       |  |                                     |                          |          |      |                |         |                   |
| <input type="checkbox"/>  | No Impact to the Material Declaration  | <input checked="" type="checkbox"/>   | Material Declarations or Product Content reports are driven from production data and will be available following the production release. Upon production release the revised reports can be obtained from the <a href="#">TI ECO website</a> . |                                     |                          |          |      |                |         |                   |

|   |                                   |                                    |                        |
|---|-----------------------------------|------------------------------------|------------------------|
| <b>Changes to product identification resulting from this PCN:</b> |                                   |                                    |                        |
| <b>Assembly Site</b>  | <b>Assembly Site Origin (22L)</b> | <b>Assembly Country Code (21L)</b> | <b>Assembly City</b>   |
| TI Clark  | QAB                               | PHL                                | Angeles City, Pampanga |
| <b>CARZ</b>   | <b>CSZ</b>                        | <b>CHN</b>                         | <b>Jiangsu</b>         |

Sample product shipping label (not actual product label)



MADE IN: Malaysia  
2DC: 2Q

|                     |          |
|---------------------|----------|
| MSL 2 / 260C/1 YEAR | SEAL DT  |
| MSL 1 / 235C/UNLIM  | 03/29/04 |

OPT:  
ITEM: 39  
LBL: 5A (L)T0:1750



(1P) SN74LS07NSR  
(Q) 2000 (D) 0336  
(31T) LOT: 3959047MLA  
(4W) TKY (1T) 7523483SI2  
(P)  
(2P) REV: (V) 0033317  
(20L) CSO: SHE (21L) CCO: USA  
(22L) ASO: MLA (23L) ACO: MYS

**Product Affected**

|               |               |
|---------------|---------------|
| TPS65197BRUYR | TPS65197BRUYT |
|---------------|---------------|



TI Information  
Selective Disclosure

**Qualification Report**

TPS65197BRUY (UMC-F8AB/LBC5) add Carsem Suzhou as 2nd A/T Site using 28pin RUY WQFN (0.4mm pitch)  
Approve Date 10-Aug-2017

**Product Attributes**

| Die Attributes      | Qual Device:<br>TPS65197BRUY | QBS Product Reference:<br>TPS65197BRUY | QBS Product Reference:<br>TPS65197RUY | QBS Process Reference:<br>TAS5613PHD | QBS Package Reference:<br>TLVDC3120IRHBR-DM5 | QBS Package Reference:<br>TPS650240RHBR-CU |
|---------------------|------------------------------|--|---------------------------------------|--------------------------------------|--|--|
| Wafer Fab Supplier  | UMC-8AB                      | UMC-8AB                                | UMC-8AB                               | UMC FAB8AB                           | DP1-DM5                                      | FR-BIP-1                                   |
| Wafer Process       | LBC5X                        | LBC5                                   | LBC5                                  | LBC5X                                | 1833C05.24LRD                                | 3370A12X3                                  |
| Assembly Site       | CARSEM SUZHOU CARZ           | CLARK                                  | CLARK                                 | TAI                                  | CARSEM SUZHOU                                | CARSEM SUZHOU                              |
| Package Family      | WQFN; 4 X 4MM                | WQFN                                   | TQFN                                  | HTQFP                                | WQFN   | WQFN                                       |
| Flammability Rating | UL 94 V-0                    | UL 94 V-0                              | UL 94 V-0                             | UL 94 V-0                            | UL 94 V-0                                    | -  |

- QBS: Qual By Similarity  
- Qual Device TPS65197BRUY is qualified at LEVEL2-260CG

**Qualification Results**

Data Displayed as: Number of lots / Total sample size / Total failed

| Type | Test Name / Condition         | Duration                 | Qual Device:<br>TPS65197BRUY | QBS Product Reference:<br>TPS65197BRUY | QBS Product Reference:<br>TPS65197RUY | QBS Process Reference:<br>TAS5613PHD | QBS Package Reference:<br>TLVDC3120IRHBR-DM5 | QBS Package Reference:<br>TPS650240RHBR-CU |
|------|-------------------------------|--------------------------|------------------------------|--|---------------------------------------|--------------------------------------|--|--|
| AC   | Autoclave 121C                | 96 Hours                 | -                            | -                                      | -                                     | 3/231/0                              | 3/231/0                                      |  |
| CDM  | ESD - CDM                     | 1500V                    | 1/3/0                        | -                                      | 1/3/0                                 | -                                    | -  |  |
| ED   | Electrical Characterization   | Per Datasheet Parameters | Pass                         | Pass                                   | Pass                                  | Pass                                 | -  |  |
| HAST | Biased HAST 130C/85%RH        | 96 Hours                 | -                            | -                                      | -                                     | 3/231/0                              | -  |  |
| HBM  | ESD - HBM                     | 4000V                    | 1/3/0                        | -                                      | -                                     | -                                    | -  |  |
| HTOL | Life Test, 155C               | 240 Hours                | -                            | -                                      | -                                     | 3/231/0                              | -  |  |
| HTSL | High Temp. Storage Bake, 150C | 1000                     | -                            | -                                      | -                                     | -                                    | 3/231/0                                      |  |
| HTSL | High Temp. Storage Bake, 170C | 420 Hours                | -                            | -                                      | -                                     | 3/231/0                              | 3/231/0                                      |  |
| LU   | Latch-up                      | (per JESD78)             | 1/3/0                        | -                                      | 1/6/0                                 | 3/18/0                               | -  |  |
| TC   | Temperature Cycle -65/150C    | 500 Cycles               | -                            | -                                      | 1/77/0                                | 3/231/0                              | 3/231/0                                      |  |
| TS   | Thermal Shock -65/150C        | 500 Cycles               | -                            | -                                      | -                                     | 3/231/0                              | -  |  |

- Preconditioning was performed for Autoclave, Unbiased HAST, THB/Biased HAST, Temperature Cycle, Thermal Shock, and HTSL, as applicable  
- The following are equivalent HTOL options based on an activation energy of 0.7eV: 125C/1k Hours, 140C/480 Hours, 150C/300 Hours, and 155C/240 Hours  
- The following are equivalent HTSL options based on an activation energy of 0.7eV: 150C/1k Hours, and 170C/420 Hours  
- The following are equivalent Temp Cycle options per JESD47: -65C/125C/700 Cycles and -65C/150C/500 Cycles  
Quality and Environmental data is available at TI's external Web site: <http://www.ti.com>  
Green/Pb-free Status:  
Qualified Pb-Free(SMT) and Green

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

| Location     | E-Mail   |
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